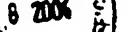| FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. NETL.001DV4	APPLICATION NO. 10/765,420
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT	APPLICANTS Jayesh R. Bhakta et al.	
(USE SEVERAL SHEETS IF NECESSARY)	FILING DATE January 27, 2004	GROUP Unknown

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
LP		6,705,877 B1	03/16/04	Li et al.			

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO

EXAMINER INITIAL		OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)

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EXAMINER	DATE CONSIDERED 08/16/2007

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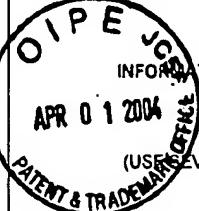| FORM PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. NETL.001DV4	APPLICATION NO. 10/765,420
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (USE SEVERAL SHEETS IF NECESSARY)		APPLICANTS Jayesh R. Bhakta et al.	
		FILING DATE January 27, 2004	GROUP Unknown

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U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
	1	4,280,176	07/21/81	Tan			
	2	4,679,167	07/07/87	Finnell			
	3	5,012,389	04/30/91	Perry			
	4	5,164,916	11/17/92	Wu et al.			
	5	5,191,404	03/02/93	Wu et al.			
	6	5,226,136	07/06/93	Nakagawa			
	7	5,303,123	04/12/94	Chandler et al.			
	8	5,383,148	01/17/95	Testa et al.			
	9	5,412,538	05/02/95	Kikinis et al.			
	10	5,428,762	06/27/95	Curran et al.			
	11	5,465,229	11/07/95	Bechtolsheim et al.			
	12	5,495,435	02/27/96	Sugahara			
	13	5,513,135	04/30/96	Dell et al.			
	14	5,532,954	07/02/96	Bechtolsheim et al.			
	15	5,541,448	07/30/96	Carpenter			
	16	5,572,691	11/05/96	Koudmani			
	17	5,631,807	05/20/97	Griffin			
	18	5,642,323	06/24/97	Kotani et al.			
	19	5,652,462	07/29/97	Matsunaga et al.			
	20	5,652,861	07/29/97	Mayo et al.			
	21	5,661,339	08/26/97	Clayton			
	22	5,691,946	11/25/97	DeBrosse et al.			
	23	5,712,811	01/27/98	Kim			
	24	5,737,192	04/07/98	Linderman			
	25	5,754,408	05/19/98	Derouiche			
	26	5,835,932	11/10/98	Rao			
	27	5,847,985	12/08/98	Mitani et al.			
	28	5,867,448	02/02/99	Mann			

EXAMINER	*(signature)*	DATE CONSIDERED	08/16/04

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FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. NETL.001DV4	APPLICATION NO. 10/765,420
INFORMATION DISCLOSURE STATEMENT BY APPLICANT	APPLICANTS Jayesh R. Bhakta et al.	
(USE SEVERAL SHEETS IF NECESSARY)	FILING DATE January 27, 2004	GROUP Unknown

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
LP	29	5,953,738	09/14/99	Rao			
	30	5,973,951	10/26/99	Bechtolsheim et al.			
	31	6,021,048	02/01/00	Smith			
	32	6,072,744	06/06/00	Kwean			
	33	6,097,619	08/01/00	Nguyen et al.			
	34	6,151,235	11/21/00	Kitagawa et al.			
	35	6,157,538	12/05/00	Ali et al.			
	36	6,181,004 B1	01/30/01	Koontz et al.			
	37	6,215,718 B1	04/10/01	Koelling			
	38	6,222,737 B1	04/24/01	Ross			
	39	6,222,739 B1	04/24/01	Bhakta et al.			
	40	6,353,539 B1	03/05/02	Horine et al.			
	41	6,502,161 B1	12/31/02	Perego et al.			
	42	6,532,158 B1	03/11/03	Buttet			
	43	6,545,895 B1	04/08/03	Li et al.			
	44	2002/0088633 A1	07/11/02	Kong et al.			
	45	2003/0014578 A1	01/16/03	Pax			
	46	2003/0048616 A1	03/13/03	Ko et al.			
	47	2003/0051091 A1	03/13/03	Leung et al.			
	48	2003/0057564 A1	03/27/03	Leedy			
	49	2003/0061447 A1	03/27/03	Perego et al.			
	50	2003/0090879 A1	05/15/03	Doblar et al.			

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT	APPLICANTS Jayesh R. Bhakta et al.	
(USE SEVERAL SHEETS IF NECESSARY)	FILING DATE January 27, 2004	GROUP Unknown

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES	NO
LP	51	JP 60034054 A	02/21/85	Japan				

EXAMINER INITIAL		OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)
LP	52	PCT International Search Report dated August 29, 2003 for counterpart PCT application No. PCT US/03/06978 filed March 6, 2003, in 5 pages.
	53	JEDEC Standard No. 21-C, 4.20.2 - 168 Pin, PC133 SDRAM Registered DIMM Design Specification, Revision 1.4, Release 11a, February 2002.
	54	JEDEC Standard No. 21-C, 4.20.3 - 144 Pin, PC133 SDRAM Unbuffered SO-DIMM, Reference Design Specification, Revision 1.02, Release 11.
	55	JEDEC Standard No. 21-C, DDR SDRAM PC2100 and PC1600 DDR SDRAM Registered DIMM Design Specification, Revision 1.3, Release 11b, January 2002.
	56	JEDEC Standard No. 21-C, 4.20.5 - 184 Pin PC1600/2100 DDR SDRAM Unbuffered DIMM Design Specification, Revision 1.1, Release 11b.
	57	JEDEC Standard No. 21-C, 4.20.6 - 200 Pin, PC2700/PC2100/PC1600 DDR SDRAM Unbuffered SO-DIMM Reference Design Specification, Revision 1.1, Release 11b, April 26, 2002.
	58	Intel, PC SDRAM Registered DIMM Design Support Document, Revision 1.2, October 1998.
	59	Intel Corporation, 66/100 MHz PC SDRAM 64-Bit Non-ECC/Parity 144 Pin Unbuffered SO-DIMM Specification, Revision 1.0, February 1999.

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